

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

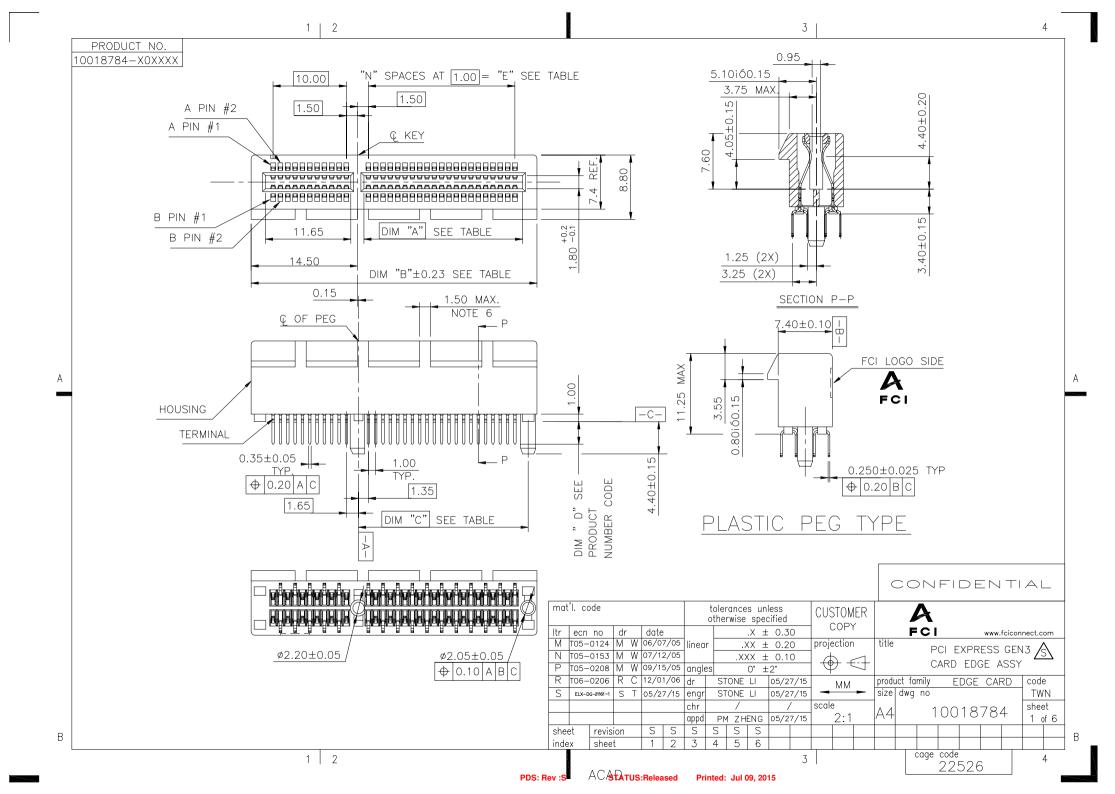
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

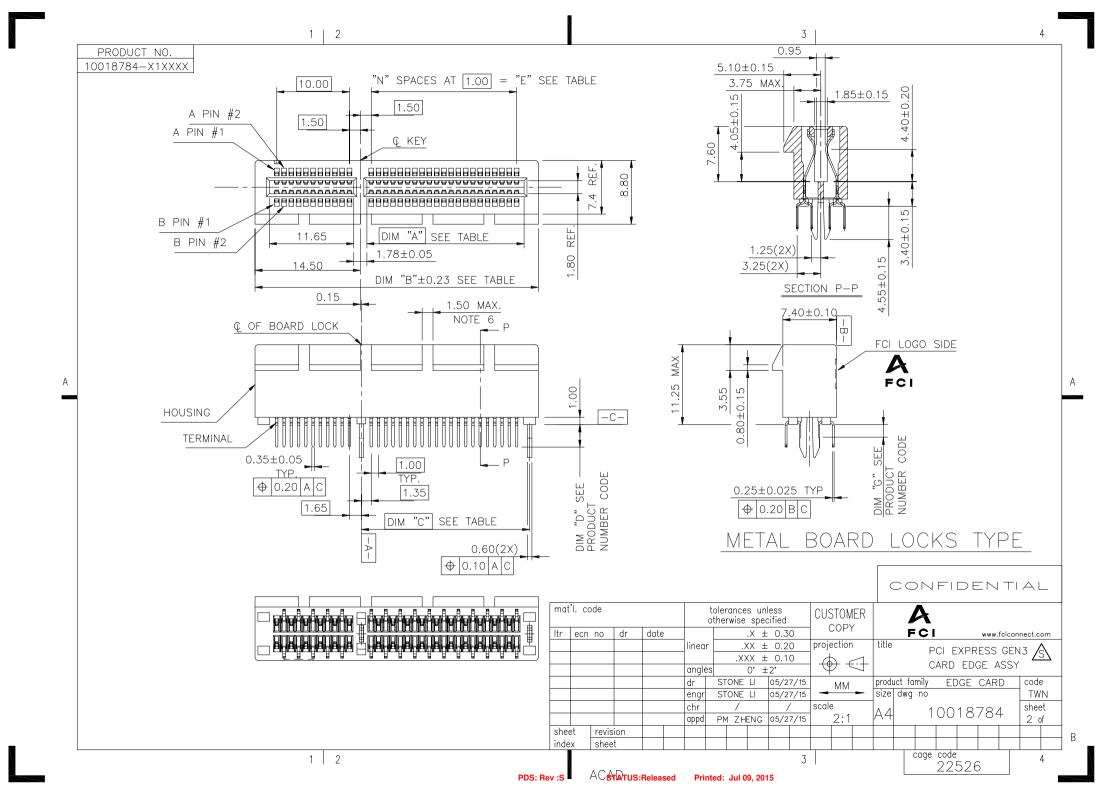
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

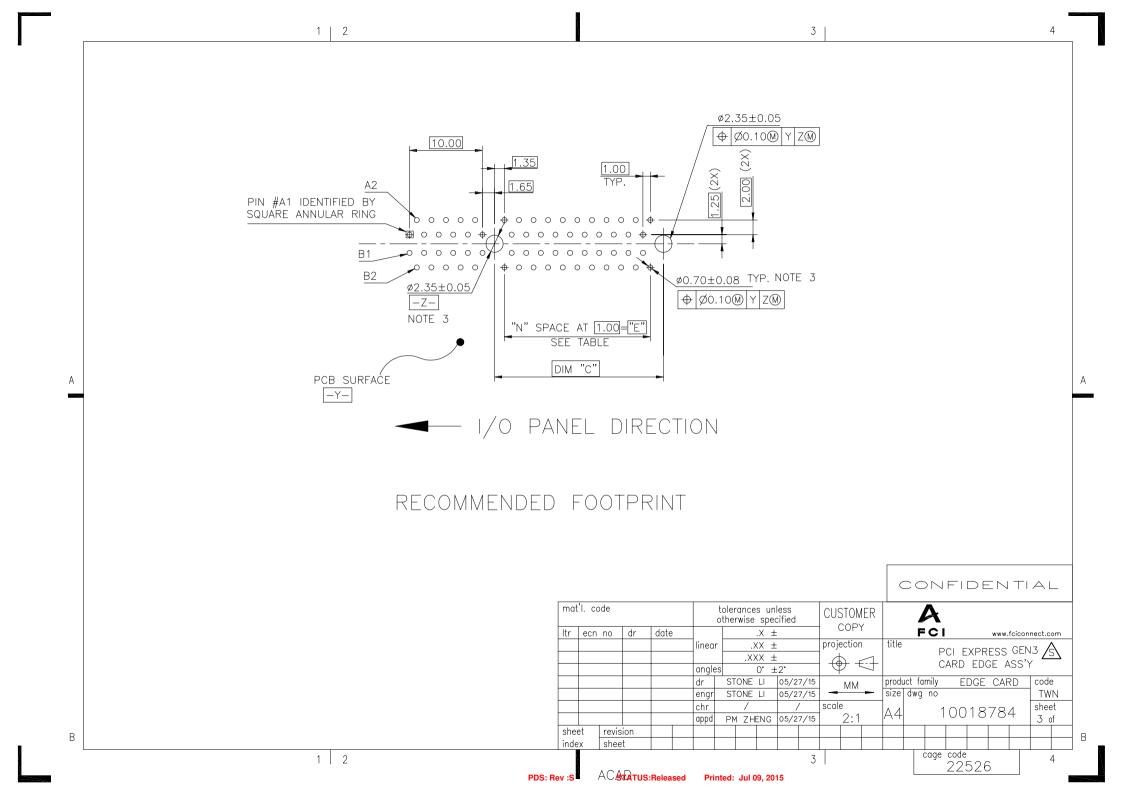


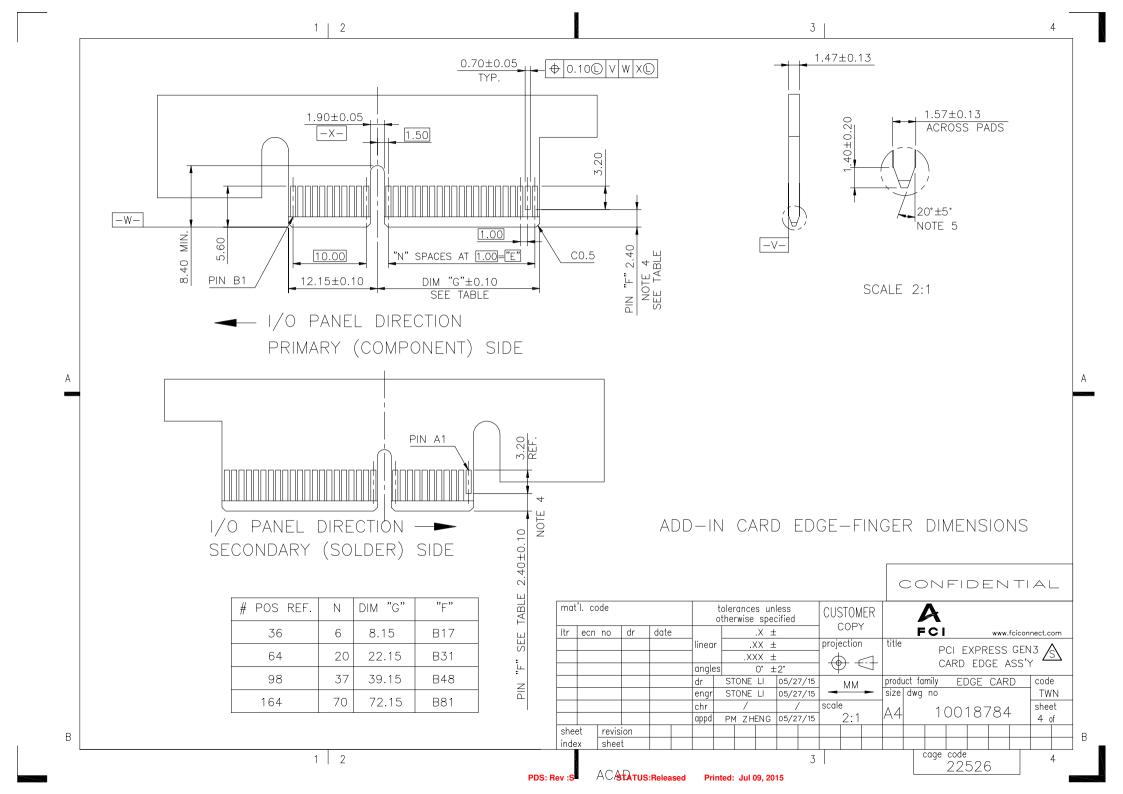












NOTES: 1.MATERIAL: HOUSING: NYLON, GLASS FILLED UL94V-O RATE, SUITABLE FOR WAVE SOLDERING. TERMINAL: COPPER ALLOY PLATING: 50u" NICKEL UNDERPLATE ALL OVER CONTACT AREA PLATING - SEE PRODUCT NUMBER CODE SOLDER TAIL: TIN/LEAD (90/10) - SEE PRODUCT NUMBER CODE 1000" MIN. OVER 500" NICKEL METAL BOARD LOCKS: COPPER ALLOY FINISH: 100u" TIN/LEAD (90/10) OVER 50u" NICKEL UNDERPLATE SEE PRODUCT NUMBER CODE 2.PRODUCT SPECIFICATION: GS-12-233 (3)THE HORIZONTAL AXIS FOR THE HOLE PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE TWO Ø2.35 HOLES. THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER OF DATUM Z. (4)NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND PIN NUMBERS "F". (5) CHAMFER EDGES MUST BE FREE OF CUTTING BURRS. FREQUENCY & LOCATION AT SUPPLIER DISCRETION. RIDGE MAY BE CONTINUOUS WITH NO BREAKS

DIM "C' CONNECTOR # POS REF. Ν DIM "A" DIM "B" 1 PORT 36 6 7.65 25.00 9.15 6.00 4 PORT 64 20 21.65 39.00 23.15 20.00 8 PORT 98 37 38.65 56.00 40.15 37.00 16 PORT 164 70 71.65 89.00 73.15 70.00

7.RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2um MINIMUM MATTE TIN OVER 1,27um MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR

5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD. - THE HOUSING WILL WITHSTAND EXPOSURE TO 240°C±5°C SOLDER BATH TEMPERATURE FOR

5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.(For 10018784-X 0 X X X X(X X) options)

PRODUCT NUMBER CODE 10018784 -x x x x x x x o o

1 2

HOUSING COLOR OPTIONS 0-WHITE 1-BLACK

TERMINAL PLATING OPTIONS

GOLD FLASH CONTACT AREA

30u" Au CONTACT AREA

0-50u" Ni UNDERPLATE 30u" Au CONTACT AREA

1-50u" Ni UNDERPLATE 15u" Au CONTACT AREA

2-50u" Ni UNDERPLATE

3-50u" Ni UNDERPLATE

4-50u" Ni ÚNDERPLATE 15u" Au CONTACT AREA

PEGS OPTIONS

0-PLASTIC PEGS

1-METAL BOARD LOCKS

100u" TIN TAIL AREA ---- COMPATIBLE ROHS

100u" TIN TAIL AREA ---- COMPATIBLE ROHS

100u" TIN TAIL AREA ---- COMPATIBLE RoHS

LEAD FREE OPTION LEAVE BLANK FOR TERMINAL PLATING 3.4.5

"LF" FOR TERMINAL PLATING OPTION 0.1.2

POS OPTIONS 0-36

1 - 642-98 3 - 164

TAIL LENGTH OPTIONS

PCB THICKNESS BOARD LOCKS DIM"G" DIM "D" 2.30 +0.25 1.56±0.10 1.70±0.15 $3.10^{+0.25}_{-0.13}$ 2.36 ± 0.10 2.50 ± 0.15

CONFIDENTIAL

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5-50u" Ni ÚNDERPLATE GOLD FLASH CONTACT AREA 100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT ROHS

100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT ROHS

100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT ROHS

sheet

PACKAGING OPTIONS

T-TRAY PACKAGING

AC STATUS: Released Printed: Jul 09, 2015

В

PDS: Rev :S

M-TRAY PACKAGING & MYLAR TAPE FOR PICK-N-PLACE. SEE FIGURE 1

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